

#2 Cell, Iconst:200/Rs, Linear Li-Ion Battery Charger

PRELIMINARY DATASHEET

General Description

FH5411A series is a double lithium battery charge management chip. The chip includes a charge state detection, the charging process, temperature detection and so on. The chip also integrates a high-precision reference voltage module in it. It uses the SOP-8L package.

FH5411A charge contains three modes: precharge, constant current charging, constant voltage charging. Constant current charging current is five times the pre-charge current; when the voltage is lower than 6.5V into the precharge mode; when the voltage is above 6.5V into the constant current charge mode, the charging current is five times as the precharge, the charging current is determined by an external resistor.

Device Information (1)

PART NUMBER PACKAGE		BODY SIZE (NOM)		
FH5411A	SOP-8L	4.90mm × 3.91mm		

(1) For all available packages, see the orderable addendum at the end of the data sheet.

Features

- Double lithium battery charge management
- Only need a few external compenents
- Pre-charge, constant current charging , constant voltage charging mode
- Temperature detection
- Two charging status
- Package type: SOP-8L

Package Information

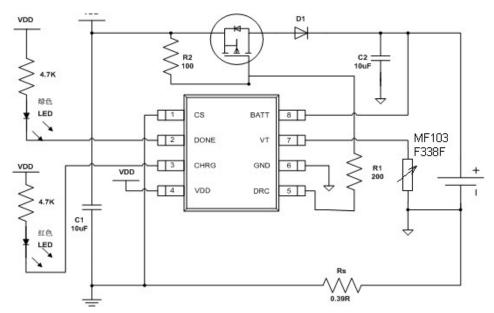
• Type: SOP-8L

Applications

- Digital camera
- PDAS
- The phone lithium battery



Typical Application Circuit



Note: D1 is a Schottky;

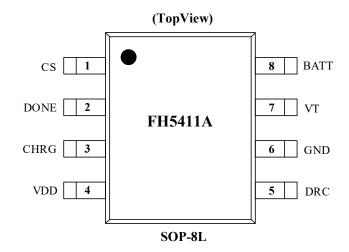
RS has been suggested that high-precision (1%) in order to ensure current accuracy, R1 and R2 is not required precision.



Pin Assignment



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Pin Description

Pin Number	Pin Name	Function Description	
1	CS	Overcharge detection pin	
2	DONE	Charge status pin1	
3	CHRG	Charge status pin2	
4	VDD	Power input	
5	DRC	External MOS or PNP control pin	
6	GND	Ground	
7	VT	Battery temperature detection pin	
8	BATT	Battery voltage detection	



Block Diagram



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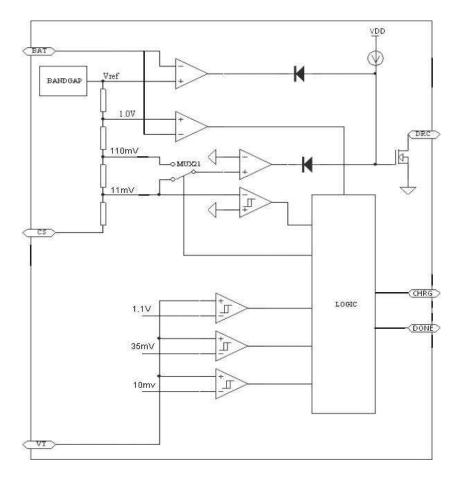


Figure 2. FH5411A block diagram



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双节线性锂电池充电管理芯片

器件概述

FH5411A 系列是一款双节锂电池充电管理芯片。该芯片包含了充电状态检测、充电过程、温度检测等,内部还集成一个高精度的基准电压模块,此芯片采用 SOP-8L 封装。

FH5411A 充电包含三种模式: 预充电,恒流充电,恒压充电。恒流充电时电流是预充电电流的 5 倍; 当电压低于 6.5V 时预充电状态; 当电压高于 6.5V 时进入恒流充电模式,此时的充电电流是预充电时的 5 倍,充电电流大小由一个外接的电阻来设置。

产品特点

- 双节锂电池充电管理
- 只需要很少的外围元件
- 预充电、恒流充电、恒压充电模式
- 温度检测
- 双灯充电状态显示
- 封装形式: SOP-8L

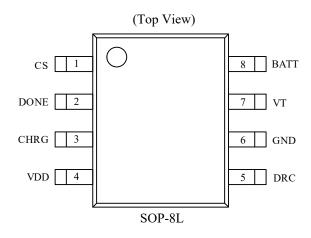
封装形式

• SOP-8L

应用领域

● 数码相机 ● PDAS ● 手机锂电池

引脚分配



引脚序号	口吻女护	4:#\3\chi_r		
SOP-8L	引脚名称	功能描述 		
1	CS	充电检测引脚		
2	DONE	充电状态显示引脚 1		
3	CHRG	充电状态显示引脚 2		
4	VDD	电源输入		
5	DRC	外接 MOS 或者 PNP 控制引脚		
6	GND	接地		
7	VT	电池温度检测引脚		
8	BATT	电池电压检测		

绝对最大额定值

参数	标号 最大额定值		单位		
输入电压	V_{DD}	V_{SS} -0.3 \sim V_{SS} +18			
DRC 端电压	Vdrc	$\begin{array}{cccc} & V_{SS}-0.3 \sim V_{SS}+18 \\ & V_{SS}-0.3 \sim 12 \\ & V_{SS}-0.3 \sim 6 \\ & V_{C} & V_{SS}-0.3 \sim 18 \\ & $			
BAT 端电压	Vbat				
CS 端电压	Vcs				
CHAG 端电压	Vchrg				
DONE 端电压	Vdone Vss-0.3~18				
NTC 端电压	TC 端电压 Vntc				
工作外围温度	作外围温度 Topa -40~+85		°C		
存储温度	Tstr	-65∼+125			

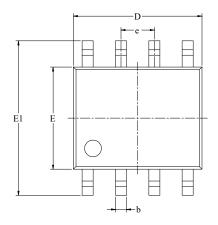
注意: 绝对最大额定值是指在任何条件下都不能超过的额定值。万一超过此额定值,有可能造成产品劣化等物理性损伤。

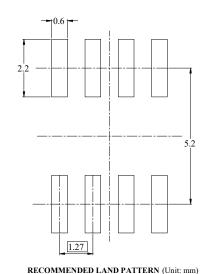


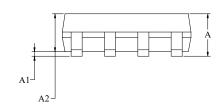
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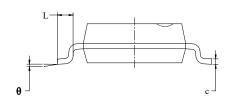
PACKAGE OUTLINE DIMENSIONS

Type: SOP-8L









Symbol	Dimensions In Millimeters		Dimensions In Inches		
	MIN	MAX	MIN	MAX	
A	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.18 5	0.200	
Е	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.24 4	
e	1.27 BSC		0.050 BSC		
L	0.400	1.270	0.016	0.050	
θ	0	8	0	8°	



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ORDERING INFORMATION

Part Number	Input Voltage	Features	Operating Temperature	Package Type	Top Mark	SPQ
FH5411ABS8	~ VSS+18.0V	 #2 Cell linear battery charger Vflog: 8.4V (typ.) Iconst: 200/Rs (typ.) Ipre: 50/Rs (typ.) 	-40°C to +85°C	SOP-8L	FH5411A <u>Y W L</u>	2500EA/Reel

Note:

- FH5411A devices are Pb-free and RoHs compliant.
- > The surface prints of our semiconductor devices are subject to change during the production process and do not involve changes in electrical parameters, and we will not separately state the notice.
- > If you have any other custom purchase needs, please contact our sales department.
- > FOCMCU Inc. reserves the right to amend and legally interpret the electrical parameters of this chip device. (http://www.fordevices.com)



ESD SENSITIVITY CAUTION

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.









Technical Documents













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▲ Update by Dec.2022